

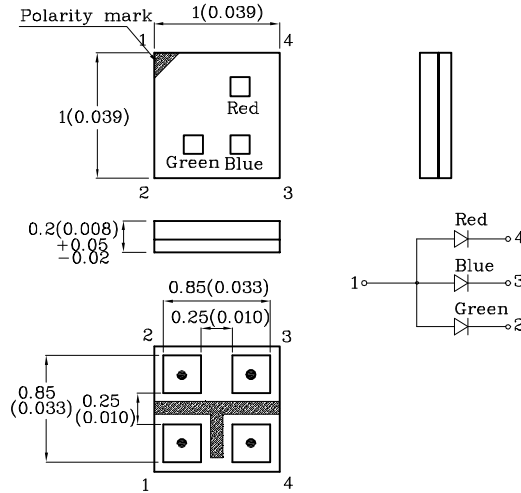
Features

- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 4,000pcs/ Reel
- MSL (Moisture Sensitivity Level):3
- Low current IF=5mA operating.
- RoHS compliant



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Package Schematics



Notes:

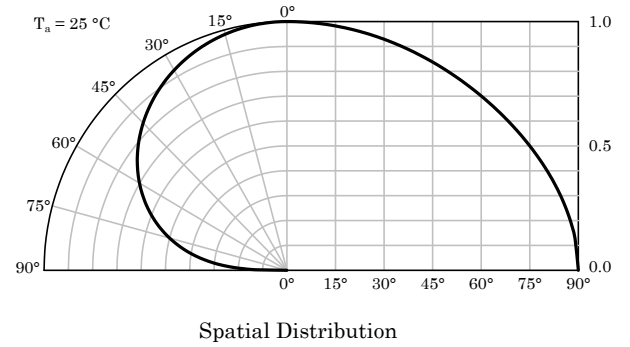
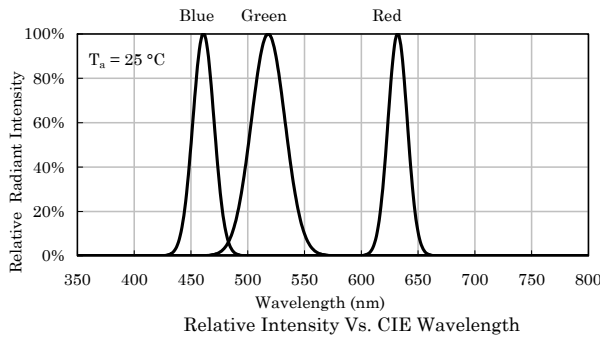
1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.1(0.004)$ " unless otherwise noted.
3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		Green (InGa N)	Blue (InGa N)	Red (AlGa InP)	Unit	Operating Characteristics (T _A =25°C)		Green (InGa N)	Blue (InGa N)	Red (AlGa InP)	Unit
Reverse Voltage	V _R	5	5	5	V	Forward Voltage (Typ.) (I _F =5mA)	V _F	3	2.9	1.95	V
Forward Current [2]	I _F	10	10	10	mA	Forward Voltage (Max.) (I _F =5mA)	V _F	3.2	3.1	2.3	V
Forward Current (Peak) Duty Cycle \leq 1/20 1ms Pulse Width	i _{FS}	50	50	50	mA	Reverse Current (Max.) (V _R =5V)	I _R	50	50	10	μA
Power Dissipation [1]	P _D	35	35	35	mW	Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =5mA)	λ _P	518*	461*	632*	nm
Electrostatic Discharge Threshold (HBM)		1000	1000	3000	V	Wavelength of Dominant Emission CIE127-2007* (Typ.) (I _F =5mA)	λ _D	527*	467*	624*	nm
Operating Temperature	T _A	-40 ~ +85			°C	Spectral Line Full Width At Half-Maximum (Typ.) (I _F =5mA)	Δλ	35	22	20	nm
Storage Temperature	T _{stg}	-40 ~ +100				Capacitance (Typ.) (V _F =0V, f=1MHz)	C	100	110	25	pF

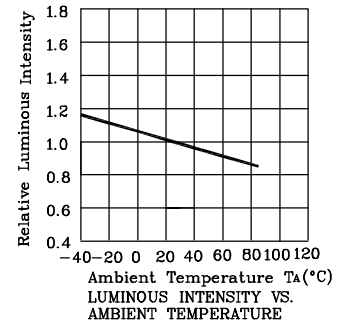
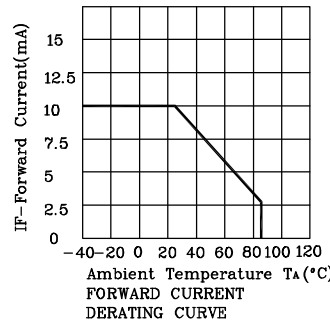
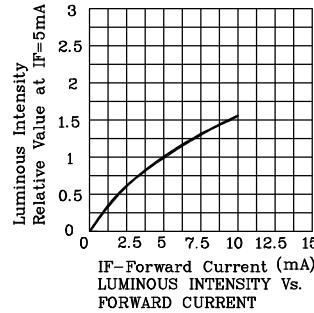
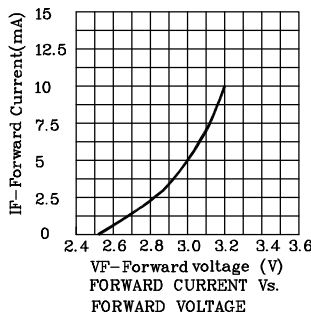
A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (I _F =5mA) mcd		Wavelength CIE127-2007* nm λ _P	Viewing Angle 2θ 1/2
				min.	typ.		
XZBGRBBRMERK150W	Green	InGaN	Water Clear	50*	79*	518*	150°
	Blue	InGaN		10*	22*	461*	
	Red	AlGaInP		15*	29*	632*	

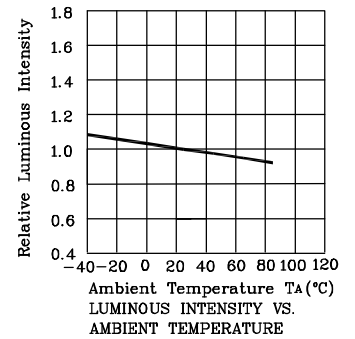
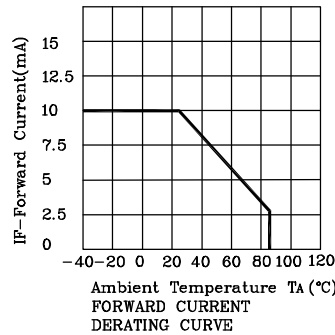
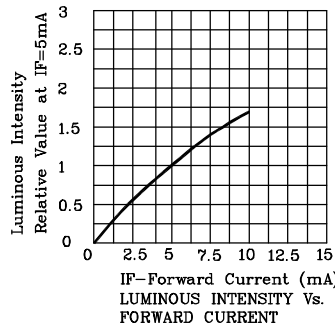
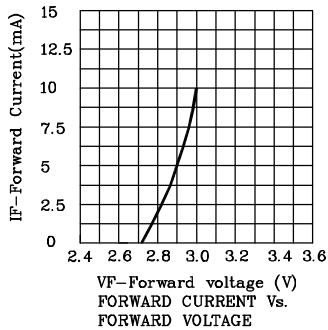
*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.



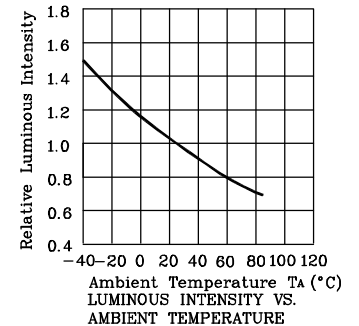
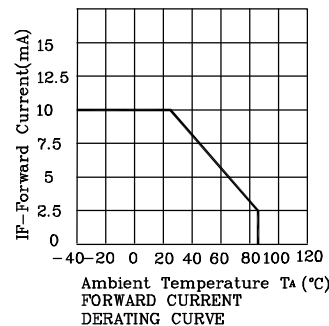
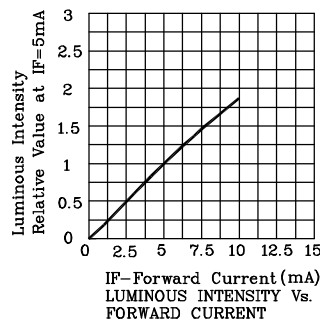
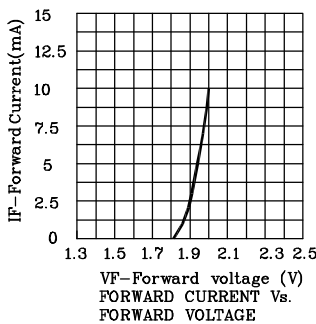
◆ Green



◆ Blue

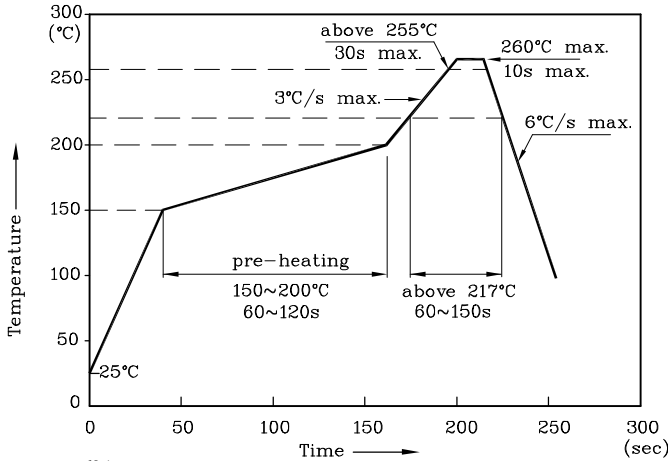


◆ Red



❖ LED is recommended for reflow soldering and soldering profile is shown below.

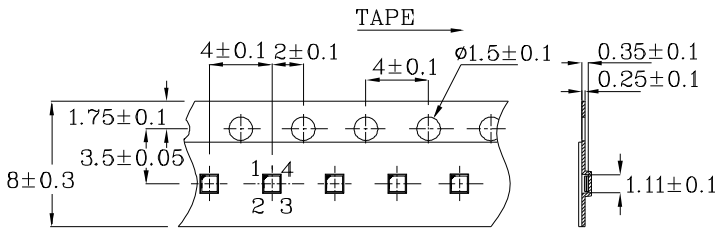
Reflow Soldering Profile for SMD Products (Pb-Free Components)



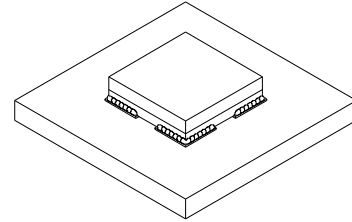
Notes:

1. All temperatures refer to the center of the package, measured on the package body surface facing up during reflow.
2. Do not apply any stress to the LED during high temperature conditions.
3. Maximum number of soldering passes: 2

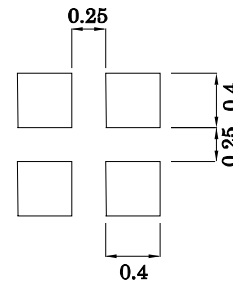
❖ Tape Specification (Units : mm)



❖ The device has a single mounting surface. The device must be mounted according to the specifications.

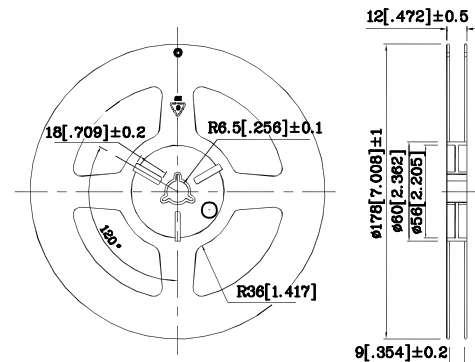


❖ Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Mask open area ratio:80%
Mask thickness:80~100um

❖ Reel Dimension



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous intensity / luminous flux: +/-15%
3. Forward Voltage: +/-0.1V
4. Within 35mW when multiple chips are lightened
5. The maximum ratings are valid for the case of lighting a single chip

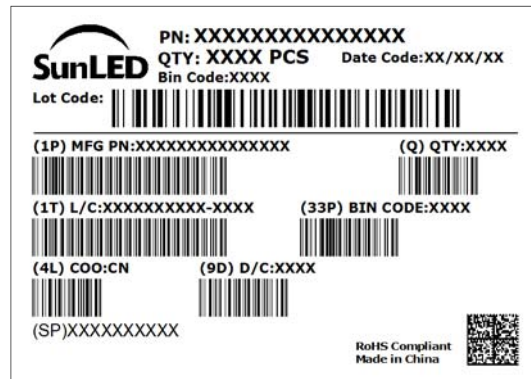
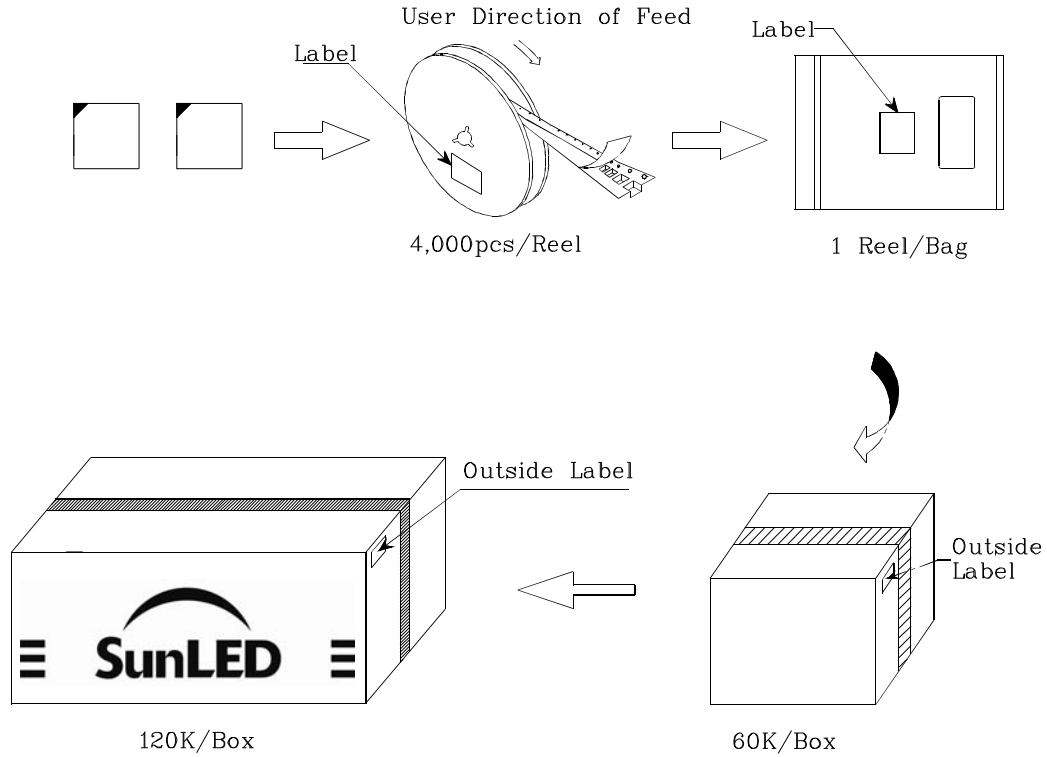
When two chips are lit at the same time, each chip should be driven at a current lower than 50% of the absolute maximum ratings

When three chips are lit at the same time, each chip should be driven at a current lower than 30% of the absolute maximum ratings

6. Duty Cycle ≤ 1/20, Pulse Width=1ms.

Note: Accuracy may depend on the sorting parameters.

PACKING & LABEL SPECIFICATIONS



TERMS OF USE

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2. Contents within this document are subject to improvement and enhancement changes without notice.
3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
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